PRESS RELEASE
For Immediate Release

PacketMicro and HSDC Announce Flexible Probing Systems for Large PCBs

Highly configurable probing systems for both horizontal and vertical PCB testing

Santa Clara, Calif., April 11, 2011 – PacketMicro and High Speed Design Center (HSDC) announce today that they are offering the “Flex Probing System” family for testing large printed circuit boards (PCB). Comprising of Flex Positioners, Flex Scopes, and Flex Bridges, this system can typically be configured for either horizontal or vertical probing of large PCB in less than 10 minutes.

“The unique, stackable structure makes our Flex Probing System the perfect solution for testing the PCB system in a vertical probing configuration,” said Ben Chia, HSDC President. “With the 2 mega-pixel Flex Scope and the articulated Flex Positioner, engineers can view and access the test points in hard-to-reach locations.”

Flex Positioner TP100 has a 4-link and 3-joint arm for quick probe placement and an independent XYZ stage for fine adjustments of probe position and contact force. Its versatile probe holder works with the most industry standard probes. Flex Bridge uses magnetic blocks and bridges to accommodate testing of PCB up to 20 inches in the horizontal configuration. Customized bridges can be ordered for printed circuit boards that are larger than 20 inches.

About PacketMicro
PacketMicro, based in Silicon Valley, provides a wide-range of high-speed probing solutions and offers world-class signal integrity design services. In addition, PacketMicro offers one-stop engineering services in the areas of wireless sensor networks, radio frequency identification (RFID), high-speed FPGA, and software development. For more information, please visit www.packetmicro.com.

About High Speed Design Center
High Speed Design Center (HSDC), based in Silicon Valley, offers designs in the area of Signal Integrity and Power Integrity for GHz high speed interconnect devices and systems. It offers probes, calibrations, probe stations and accessories. HSDC also provides engineering services in measurements and simulations. For more information, please visit www.highspeedDC.com

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